

Cascadable Silicon Bipolar MMIC Amplifiers

Technical Data

MSA-0435, -0436

Features

- **Cascadable 50 Ω Gain Block**
- **3 dB Bandwidth:**
DC to 3.8 GHz
- **12.5 dBm Typical P_{1 dB} at 1.0 GHz**
- **8.5 dB Typical Gain at 1.0 GHz**
- **Unconditionally Stable (k > 1)**
- **Cost Effective Ceramic Microstrip Package**

Description

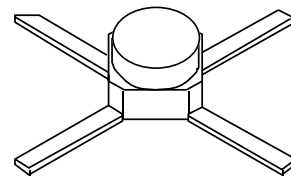
The MSA-0435 is a high performance silicon bipolar Monolithic Microwave Integrated Circuit (MMIC) housed in a cost effective, microstrip package. This MMIC is

designed for use as a general purpose 50 Ω gain block. Typical applications include narrow and broad band IF and RF amplifiers in industrial and military applications.

The MSA-series is fabricated using HP's 10 GHz f_T , 25 GHz f_{MAX} , silicon bipolar MMIC process which uses nitride self-alignment, ion implantation, and gold metallization to achieve excellent performance, uniformity and reliability. The use of an external bias resistor for temperature and current stability also allows bias flexibility.

Available in cut lead version (package 36) as MSA-0436.

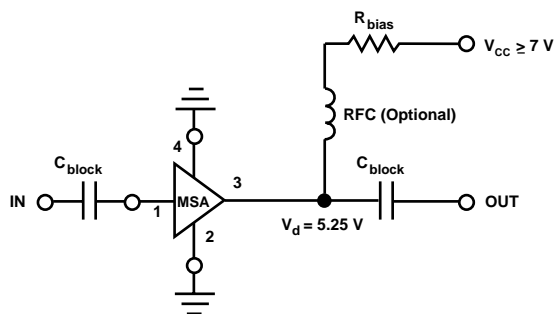
35 micro-X Package^[1]



Note:

1. Short leaved 36 package available upon request.

Typical Biasing Configuration



MSA-0435, -0436 Absolute Maximum Ratings

| Parameter | Absolute Maximum ^[1] |
|------------------------------------|---------------------------------|
| Device Current | 100 mA |
| Power Dissipation ^[2,3] | 650 mW |
| RF Input Power | +13 dBm |
| Junction Temperature | 200°C |
| Storage Temperature ^[4] | -65 to 200°C |

Thermal Resistance^[2,5]:

$$\theta_{jc} = 140^{\circ}\text{C}/\text{W}$$

Notes:

1. Permanent damage may occur if any of these limits are exceeded.
2. $T_{\text{CASE}} = 25^{\circ}\text{C}$.
3. Derate at $7.1 \text{ mW}/^{\circ}\text{C}$ for $T_{\text{C}} > 109^{\circ}\text{C}$.
4. Storage above $+150^{\circ}\text{C}$ may tarnish the leads of this package making it difficult to solder into a circuit.
5. The small spot size of this technique results in a higher, though more accurate determination of q_{jc} than do alternate methods. See MEASUREMENTS section "Thermal Resistance" for more information.

Electrical Specifications^[1], $T_{\text{A}} = 25^{\circ}\text{C}$

| Symbol | Parameters and Test Conditions: $I_{\text{d}} = 50 \text{ mA}$, $Z_{\text{o}} = 50 \Omega$ | Units | Min. | Typ. | Max. |
|-----------------------|---|-------|------|-----------|-----------|
| G _P | Power Gain ($ S_{21} ^2$) f = 0.1 GHz | dB | 7.5 | 8.5 | 9.5 |
| ΔG_{P} | Gain Flatness f = 0.1 to 2.5 GHz | dB | | ± 0.6 | ± 1.0 |
| f _{3 dB} | 3 dB Bandwidth | GHz | | 3.8 | |
| VSWR | Input VSWR f = 0.1 to 2.5 GHz | | | 1.4:1 | |
| | Output VSWR f = 0.1 to 2.5 GHz | | | 1.9:1 | |
| NF | 50 Ω Noise Figure f = 1.0 GHz | dB | | 6.5 | |
| P _{1 dB} | Output Power at 1 dB Gain Compression f = 1.0 GHz | dBm | | 12.5 | |
| IP ₃ | Third Order Intercept Point f = 1.0 GHz | dBm | | 25.5 | |
| t _D | Group Delay f = 1.0 GHz | psec | | 125 | |
| V _d | Device Voltage | V | 4.75 | 5.25 | 5.75 |
| dV/dT | Device Voltage Temperature Coefficient | mV/°C | | -8.0 | |

Note:

1. The recommended operating current range for this device is 30 to 70 mA. Typical performance as a function of current is on the following page.

Part Number Ordering Information

| Part Number | No. of Devices | Container |
|--------------|----------------|----------------|
| MSA-0435 | 10 | Strip |
| MSA-0436-BLK | 100 | Antistatic Bag |
| MSA-0436-TR1 | 1000 | 7" Reel |

For more information, see "Tape and Reel Packaging for Semiconductor Devices".

MSA-0435, -0436 Typical Scattering Parameters ($Z_0 = 50 \Omega$, $T_A = 25^\circ\text{C}$, $I_d = 50 \text{ mA}$)

| Freq. GHz | S_{11} | | S_{21} | | | S_{12} | | | S_{22} | |
|--------------|----------|------|----------|------|-----|----------|------|-----|----------|------|
| | Mag | Ang | dB | Mag | Ang | dB | Mag | Ang | Mag | Ang |
| 0.1 | .08 | 175 | 8.5 | 2.67 | 175 | -16.4 | .151 | 1 | .20 | -10 |
| 0.2 | .08 | 172 | 8.5 | 2.68 | 170 | -16.3 | .153 | 2 | .20 | -16 |
| 0.4 | .07 | 171 | 8.5 | 2.67 | 161 | -16.4 | .151 | 3 | .20 | -33 |
| 0.6 | .07 | 166 | 8.5 | 2.66 | 151 | -16.2 | .155 | 6 | .21 | -45 |
| 0.8 | .05 | 169 | 8.4 | 2.64 | 142 | -16.1 | .156 | 8 | .22 | -57 |
| 1.0 | .05 | 175 | 8.3 | 2.61 | 136 | -16.0 | .159 | 10 | .24 | -68 |
| 1.5 | .04 | -142 | 8.1 | 2.55 | 109 | -15.0 | .178 | 13 | .26 | -96 |
| 2.0 | .09 | -145 | 7.8 | 2.46 | 87 | -14.2 | .196 | 15 | .28 | -123 |
| 2.5 | .14 | -154 | 7.3 | 2.33 | 71 | -13.1 | .221 | 18 | .31 | -140 |
| 3.0 | .22 | -175 | 6.6 | 2.14 | 50 | -12.5 | .238 | 14 | .33 | -160 |
| 3.5 | .28 | 170 | 5.8 | 1.94 | 32 | -11.7 | .260 | 9 | .35 | -173 |
| 4.0 | .34 | 156 | 4.8 | 1.74 | 15 | -11.3 | .271 | 4 | .34 | -179 |
| 4.5 | .37 | 140 | 3.9 | 1.57 | -1 | -10.7 | .291 | -2 | .33 | -171 |
| 5.0 | .42 | 120 | 3.0 | 1.41 | -16 | -10.4 | .302 | -8 | .32 | -160 |

A model for this device is available in the DEVICE MODELS section.

Typical Performance, $T_A = 25^\circ\text{C}$

(unless otherwise noted)

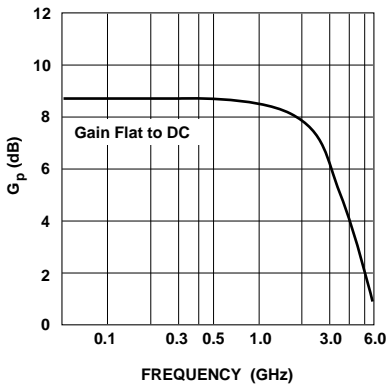


Figure 1. Typical Power Gain vs. Frequency, $T_A = 25^\circ\text{C}$, $I_d = 50 \text{ mA}$.

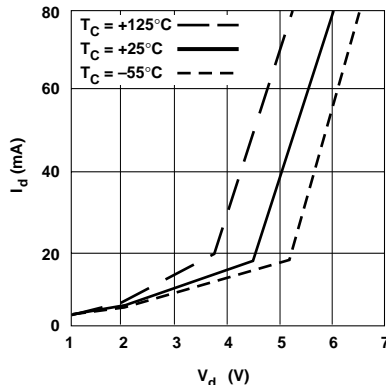


Figure 2. Device Current vs. Voltage.

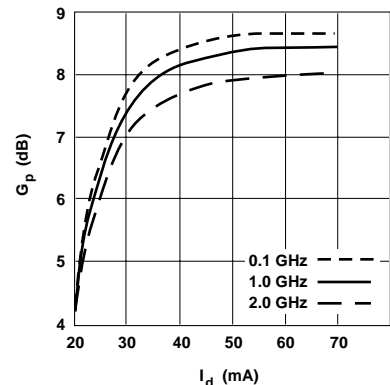


Figure 3. Power Gain vs. Current.

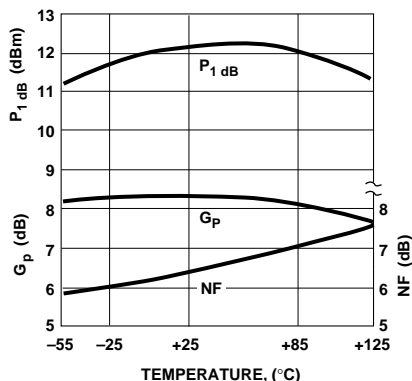


Figure 4. Output Power at 1 dB Gain Compression, NF and Power Gain vs. Case Temperature, $f = 1.0 \text{ GHz}$, $I_d = 50 \text{ mA}$.

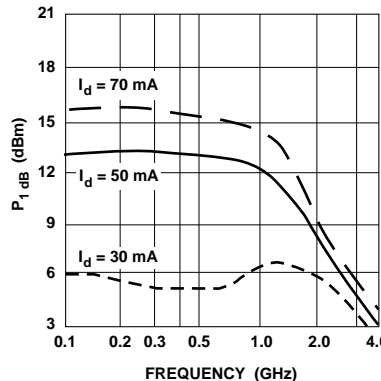


Figure 5. Output Power at 1 dB Gain Compression vs. Frequency.

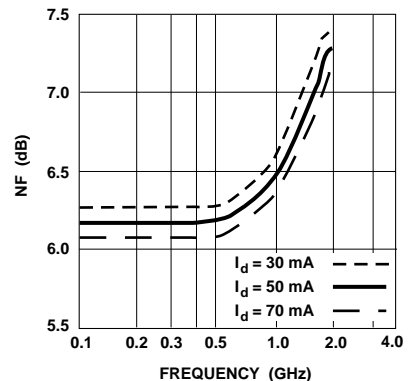


Figure 6. Noise Figure vs. Frequency.

35 micro-X Package Dimensions

